

1.9

1.9

29

Α

MHz



Low-Profile Molded Inductor 4.7µH

APPLICATIONS



- Battery-powered devices
- High switching frequency SMPS

ELECTRICAL CHARACTERISTICS

- IoT
- Wearable
- Portable devices
- Input filters

FEATURES

- Size 2.0mmx1.6mmx1.0mm
- Low Profile
- Low Audible Noise
- Molded Construction
- Soft Saturation
- Stable Over High Temperatures
- Low DCR
- Max Operating Temp +125°C
- RoHS/REACH-Compliant, Halogen-Free

Parameter			Value	Unit
Inductance (1)	L	±20%	4.7	μΗ
Resistance	R _{DC}	typ	215	mΩ
Resistance MAX	RDC MAX	max	252	$\boldsymbol{m}\boldsymbol{\Omega}$
Rated Current (2)	I R	typ	1.5	Α

ISAT 25°C

ISAT 100°C

 f_r

typ

typ

typ

GENERAL SPECIFICATIONS		
(1) Inductance	Measured at 100kHz, 100mA	
(2) Rated Current	Rated current will cause the coil temperature rise ΔT of 40K I_R measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35 μ m Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.	
(3) Saturation Current 25°C	Saturation current will cause L to drop from 30% at 25°C ambient temperature	
(4) Saturation Current 100°C	Saturation current will cause L to drop from 30% at 100°C ambient temperature	
Temperature Test Condition	Electrical specifications measured at 25°C, 35% RH if not given differently	
Operating Condition	Operating temperature: -40°C to +125°C (including temp rise)	
	Should not exceed +125°C under worst-case operation conditions	
Storage Condition	Tape and Reel packaging: -10°C to +40°C	
	Humidity: <50% RH	

Saturation Current 25°C (3)

Saturation Current 100°C (4)

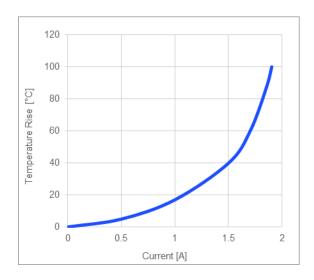
Resonance Frequency

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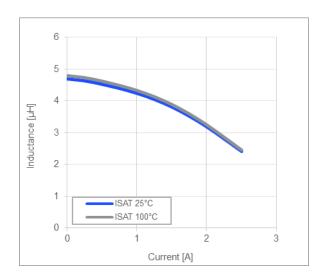


TYPICAL PERFORMANCE CURVES

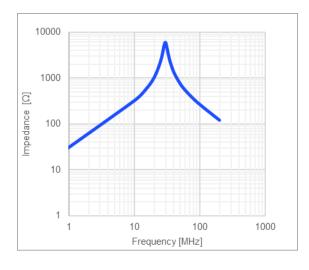
Temperature Rise vs. Current



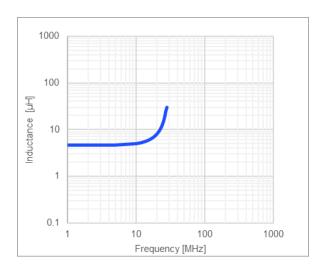
Inductance vs. Current



Impedance vs. Frequency

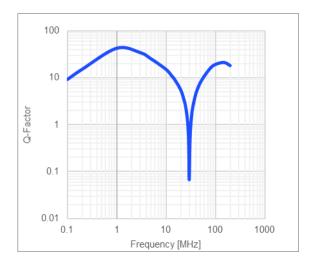


Inductance vs. Frequency

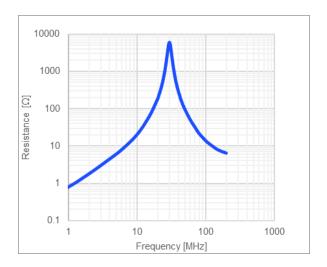




Quality Factor vs. Frequency

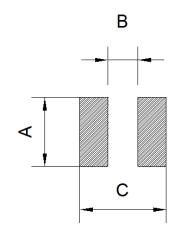


AC Resistance vs. Frequency





LAND PATTERN		
Dimensions		
Α	1.6 ref.	
В	0.50 ref.	
С	2.0 ref.	
	(unit in mm)	

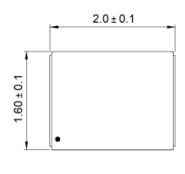


TOP MARKING

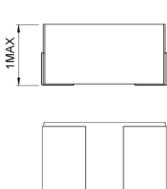
PRODUCT PACKAGE AND DIMENSIONS

Dimensions

(unit in mm)







0.60 Typ.



ORDERING INFORMATION					
Part Number	L (1)	RDC	I _R ⁽²⁾	I _{SAT 25°C} (3)	I _{SAT 100°C} (4)
	typ (µH)	typ (mΩ)	typ (A)	typ (A)	typ (A)
MPL-AT2010-R47	0.47	27	4.4	5.7	5.7
MPL-AT2010-R68	0.68	41	3.5	4.9	4.9
MPL-AT2010-1R0	1.0	50	3.2	4.2	4.2
MPL-AT2010-1R5	1.5	97	2.4	3.2	3.2
MPL-AT2010-2R2	2.2	137	2.2	2.7	2.7
MPL-AT2010-4R7	4.7	215	1.5	1.9	1.9

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